



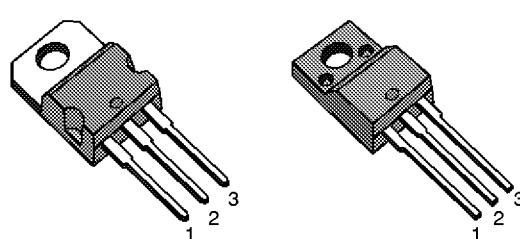
**SGS-THOMSON**  
MICROELECTRONICS

**STP50N06L**  
**STP50N06LFI**

## N - CHANNEL ENHANCEMENT MODE LOW THRESHOLD POWER MOS TRANSISTOR

| TYPE        | V <sub>DSS</sub> | R <sub>DS(on)</sub> | I <sub>D</sub> |
|-------------|------------------|---------------------|----------------|
| STP50N06L   | 60 V             | < 0.028 Ω           | 50 A           |
| STP50N06LFI | 60 V             | < 0.028 Ω           | 27 A           |

- TYPICAL R<sub>DS(on)</sub> = 0.024 Ω
- AVALANCHE RUGGED TECHNOLOGY
- 100% AVALANCHE TESTED
- REPETITIVE AVALANCHE DATA AT 100°C
- LOW GATE CHARGE
- HIGH CURRENT CAPABILITY
- LOGIC LEVEL COMPATIBLE INPUT
- 175°C OPERATING TEMPERATURE
- APPLICATION ORIENTED CHARACTERIZATION



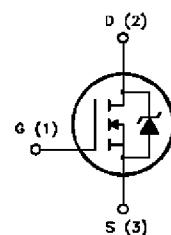
TO-220

ISOWATT220

### APPLICATIONS

- HIGH CURRENT, HIGH SPEED SWITCHING
- SOLENOID AND RELAY DRIVERS
- REGULATORS
- DC-DC & DC-AC CONVERTERS
- MOTOR CONTROL, AUDIO AMPLIFIERS
- AUTOMOTIVE ENVIRONMENT (INJECTION, ABS, AIR-BAG, LAMPDRIVERS, Etc.)

### INTERNAL SCHEMATIC DIAGRAM



### ABSOLUTE MAXIMUM RATINGS

| Symbol             | Parameter   | Value      |             | Unit |
|--------------------|---|------------|-------------|------|
|                    |   | STP50N06L  | STP50N06LFI |      |
| V <sub>DS</sub>    | Drain-source Voltage (V <sub>GS</sub> = 0)            | 60         |             | V    |
| V <sub>DGR</sub>   | Drain-gate Voltage (R <sub>GS</sub> = 20 kΩ)          | 60         |             | V    |
| V <sub>GS</sub>    | Gate-source Voltage                                   | ± 15       |             | V    |
| I <sub>D</sub>     | Drain Current (continuous) at T <sub>c</sub> = 25 °C  | 50         | 27          | A    |
| I <sub>D</sub>     | Drain Current (continuous) at T <sub>c</sub> = 100 °C | 35         | 19          | A    |
| I <sub>DM(•)</sub> | Drain Current (pulsed)                                | 200        | 200         | A    |
| P <sub>tot</sub>   | Total Dissipation at T <sub>c</sub> = 25 °C           | 150        | 45          | W    |
|                    | Derating Factor                                       | 1          | 0.3         | W/°C |
| V <sub>ISO</sub>   | Insulation Withstand Voltage (DC)                     | —          | 2000        | V    |
| T <sub>stg</sub>   | Storage Temperature                                   | -65 to 175 |             | °C   |
| T <sub>j</sub>     | Max. Operating Junction Temperature                   | 175        |             | °C   |

(•) Pulse width limited by safe operating area

# STP50N06L/FI

## THERMAL DATA

|   |   | <b>TO-220</b> | <b>ISOWATT220</b>  |                    |
|---|---|---------------|--------------------|--------------------|
| R <sub>thj-case</sub>                         | Thermal Resistance Junction-case                                    | Max           | 1                  | 3.33 °C/W          |
| R <sub>thj-amb</sub><br>R <sub>thc-sink</sub> | Thermal Resistance Junction-ambient<br>Thermal Resistance Case-sink | Max<br>Typ    | 62.5<br>0.5<br>300 | °C/W<br>°C/W<br>°C |
| T <sub>l</sub>                                | Maximum Lead Temperature For Soldering Purpose                      |               |                    |                    |

## AVALANCHE CHARACTERISTICS

| <b>Symbol</b>   | <b>Parameter</b>   | <b>Max Value</b> | <b>Unit</b> |
|-----------------|--|------------------|-------------|
| I <sub>AR</sub> | Avalanche Current, Repetitive or Not-Repetitive (pulse width limited by T <sub>j</sub> max, δ < 1%)                          | 50               | A           |
| E <sub>AS</sub> | Single Pulse Avalanche Energy (starting T <sub>j</sub> = 25 °C, I <sub>D</sub> = I <sub>AR</sub> , V <sub>DD</sub> = 25 V)   | 400              | mJ          |
| E <sub>AR</sub> | Repetitive Avalanche Energy (pulse width limited by T <sub>j</sub> max, δ < 1%)  | 100              | mJ          |
| I <sub>AR</sub> | Avalanche Current, Repetitive or Not-Repetitive (T <sub>c</sub> = 100 °C, pulse width limited by T <sub>j</sub> max, δ < 1%) | 35               | A           |

## ELECTRICAL CHARACTERISTICS (T<sub>case</sub> = 25 °C unless otherwise specified)

OFF

| <b>Symbol</b>        | <b>Parameter</b>                                      | <b>Test Conditions</b>   | <b>Min.</b> | <b>Typ.</b> | <b>Max.</b> | <b>Unit</b> |
|----------------------|---|--|-------------|-------------|-------------|-------------|
| V <sub>(BR)DSS</sub> | Drain-source Breakdown Voltage                        | I <sub>D</sub> = 250 μA V <sub>GS</sub> = 0  | 60          |             |             | V           |
| I <sub>DSS</sub>     | Zero Gate Voltage Drain Current (V <sub>GS</sub> = 0) | V <sub>DS</sub> = Max Rating<br>V <sub>DS</sub> = Max Rating × 0.8 T <sub>c</sub> = 125 °C |             |             | 250<br>1000 | μA<br>μA    |
| I <sub>GSS</sub>     | Gate-body Leakage Current (V <sub>DS</sub> = 0)       | V <sub>GS</sub> = ± 15 V   |             |             | ± 100       | nA          |

ON (\*)

| <b>Symbol</b>      | <b>Parameter</b>                  | <b>Test Conditions</b>   | <b>Min.</b> | <b>Typ.</b>    | <b>Max.</b>    | <b>Unit</b> |
|--------------------|-----------------------------------|--|-------------|----------------|----------------|-------------|
| V <sub>G(th)</sub> | Gate Threshold Voltage            | V <sub>DS</sub> = V <sub>GS</sub> I <sub>D</sub> = 250 μA  | 1           | 1.6            | 2.5            | V           |
| R <sub>D(on)</sub> | Static Drain-source On Resistance | V <sub>GS</sub> = 5 V I <sub>D</sub> = 25 A<br>V <sub>GS</sub> = 5 V I <sub>D</sub> = 25 A T <sub>c</sub> = 100 °C |             | 0.024<br>0.056 | 0.028<br>0.056 | Ω<br>Ω      |
| I <sub>D(on)</sub> | On State Drain Current            | V <sub>DS</sub> > I <sub>D(on)</sub> × R <sub>D(on)max</sub><br>V <sub>GS</sub> = 10 V                             | 50          |                |                | A           |

## DYNAMIC

| <b>Symbol</b>  | <b>Parameter</b>  | <b>Test Conditions</b>   | <b>Min.</b> | <b>Typ.</b>        | <b>Max.</b>        | <b>Unit</b>    |
|--|---|--|-------------|--------------------|--------------------|----------------|
| g <sub>fs</sub> (*)                                      | Forward Transconductance  | V <sub>DS</sub> > I <sub>D(on)</sub> × R <sub>D(on)max</sub> I <sub>D</sub> = 25 A | 17          | 31                 |                    | S              |
| C <sub>iss</sub><br>C <sub>oss</sub><br>C <sub>rss</sub> | Input Capacitance<br>Output Capacitance<br>Reverse Transfer Capacitance | V <sub>DS</sub> = 25 V f = 1 MHz V <sub>GS</sub> = 0                               |             | 2000<br>660<br>160 | 2600<br>900<br>220 | pF<br>pF<br>pF |

**ELECTRICAL CHARACTERISTICS (continued)****SWITCHING ON**

| <b>Symbol</b>                 | <b>Parameter</b>   | <b>Test Conditions</b>   | <b>Min.</b> | <b>Typ.</b>    | <b>Max.</b> | <b>Unit</b>      |
|-------------------------------|--|--|-------------|----------------|-------------|------------------|
| $t_{d(on)}$<br>$t_r$          | Turn-on Time<br>Rise Time                                    | $V_{DD} = 25 \text{ V}$ $I_D = 25 \text{ A}$<br>$R_G = 50 \Omega$ $V_{GS} = 5 \text{ V}$<br>(see test circuit, figure 3) |             | 95<br>550      | 140<br>800  | ns<br>ns         |
| $(di/dt)_{on}$                | Turn-on Current Slope  | $V_{DD} = 40 \text{ V}$ $I_D = 50 \text{ A}$<br>$R_G = 50 \Omega$ $V_{GS} = 5 \text{ V}$<br>(see test circuit, figure 5) |             | 100            |             | A/ $\mu\text{s}$ |
| $Q_g$<br>$Q_{gs}$<br>$Q_{gd}$ | Total Gate Charge<br>Gate-Source Charge<br>Gate-Drain Charge | $V_{DD} = 80 \text{ V}$ $I_D = 50 \text{ A}$ $V_{GS} = 5 \text{ V}$  |             | 42<br>11<br>25 | 60          | nC<br>nC<br>nC   |

**SWITCHING OFF**

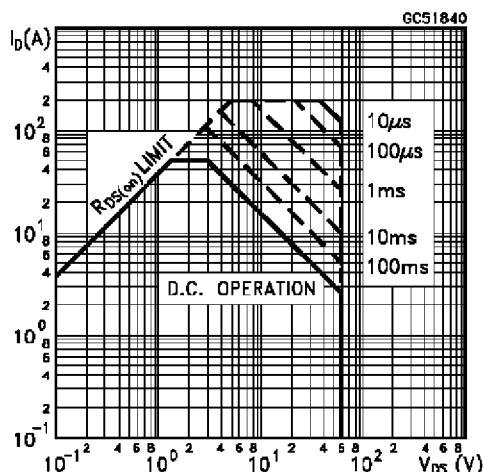
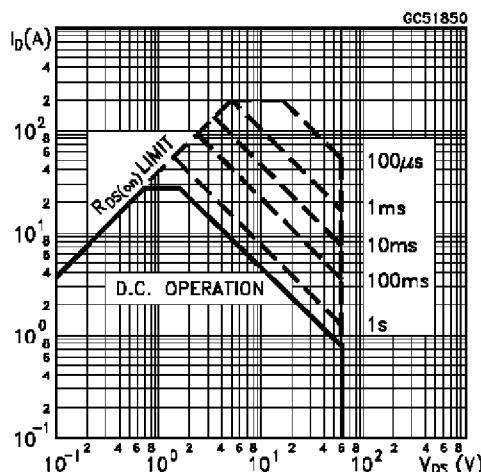
| <b>Symbol</b>                   | <b>Parameter</b>                                      | <b>Test Conditions</b>   | <b>Min.</b> | <b>Typ.</b>       | <b>Max.</b>       | <b>Unit</b>    |
|---------------------------------|---|--|-------------|-------------------|-------------------|----------------|
| $t_{r(Voff)}$<br>$t_f$<br>$t_c$ | Off-voltage Rise Time<br>Fall Time<br>Cross-over Time | $V_{DD} = 40 \text{ V}$ $I_D = 50 \text{ A}$<br>$R_G = 50 \Omega$ $V_{GS} = 5 \text{ V}$<br>(see test circuit, figure 5) |             | 145<br>215<br>380 | 210<br>310<br>550 | ns<br>ns<br>ns |

**SOURCE DRAIN DIODE**

| <b>Symbol</b>                     | <b>Parameter</b>  | <b>Test Conditions</b>   | <b>Min.</b> | <b>Typ.</b>      | <b>Max.</b> | <b>Unit</b>              |
|-----------------------------------|---|--|-------------|------------------|-------------|--------------------------|
| $I_{SD}$<br>$I_{SDM}(\bullet)$    | Source-drain Current<br>Source-drain Current<br>(pulsed)                              |  |             |                  | 50<br>200   | A<br>A                   |
| $V_{SD} (\ast)$                   | Forward On Voltage  | $I_{SD} = 50 \text{ A}$ $V_{GS} = 0$   |             |                  | 1.6         | V                        |
| $t_{rr}$<br>$Q_{rr}$<br>$I_{RRM}$ | Reverse Recovery<br>Time<br>Reverse Recovery<br>Charge<br>Reverse Recovery<br>Current | $I_{SD} = 50 \text{ A}$ $di/dt = 100 \text{ A}/\mu\text{s}$<br>$V_{DD} = 30 \text{ V}$ $T_j = 150^\circ\text{C}$<br>(see test circuit, figure 5) |             | 110<br>0.27<br>5 |             | ns<br>$\mu\text{C}$<br>A |

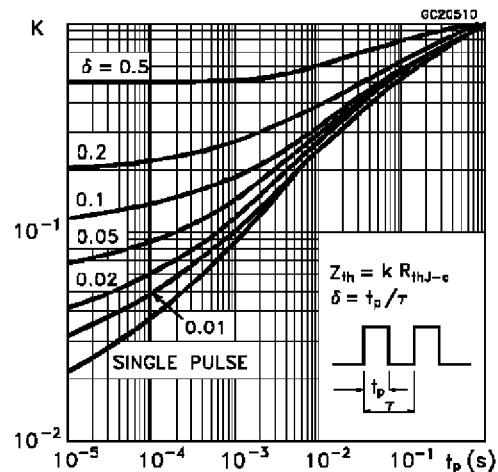
(\*) Pulsed: Pulse duration = 300  $\mu\text{s}$ , duty cycle 1.5%

(\bullet) Pulse width limited by safe operating area

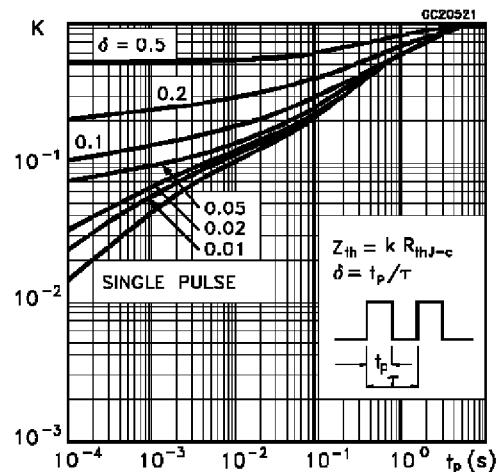
**Safe Operating Areas For TO-220****Safe Operating Areas For ISOWATT220**

## STP50N06L/FI

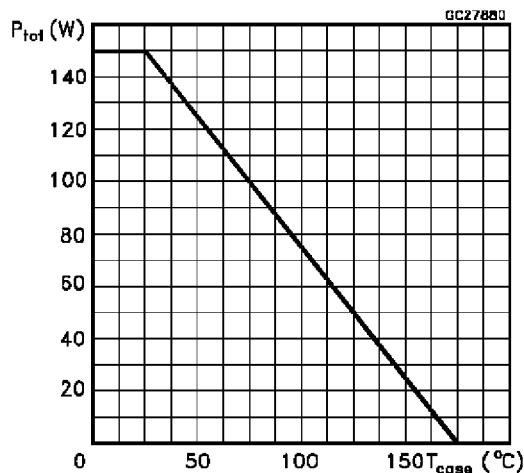
Thermal Impedance For TO-220



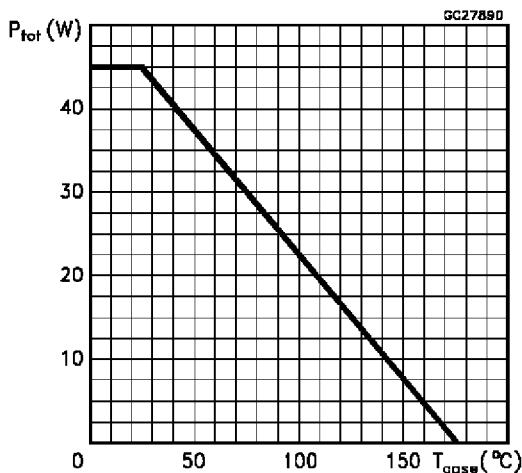
Thermal Impedance For ISOWATT220



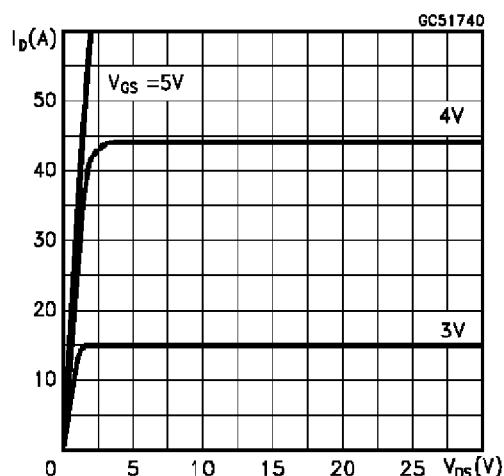
Derating Curve For TO-220



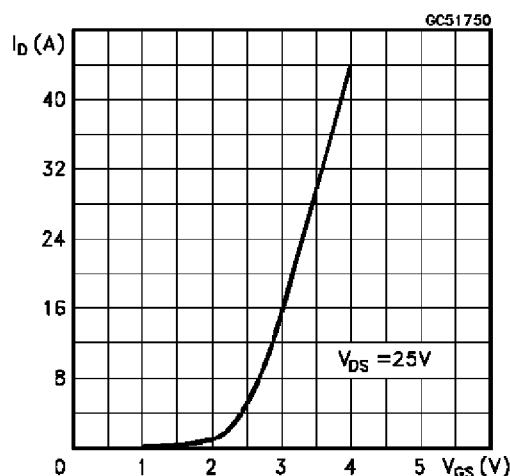
Derating Curve For ISOWATT220



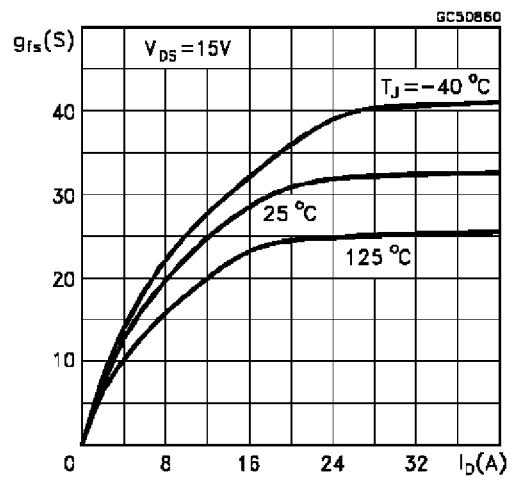
Output Characteristics



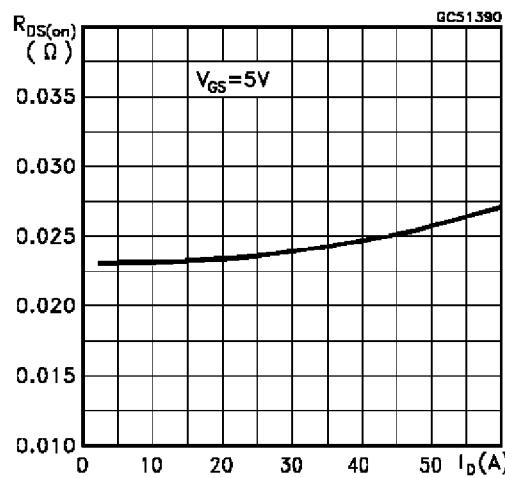
Transfer Characteristics



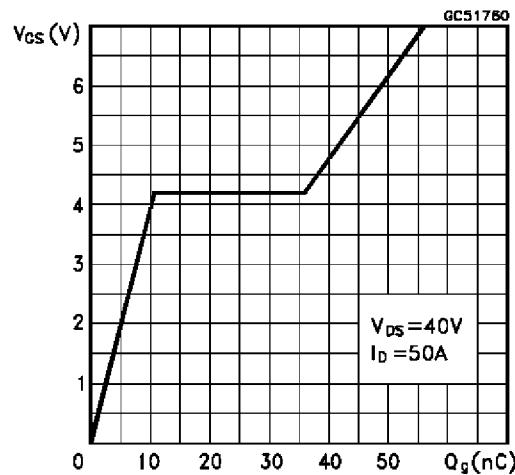
Transconductance



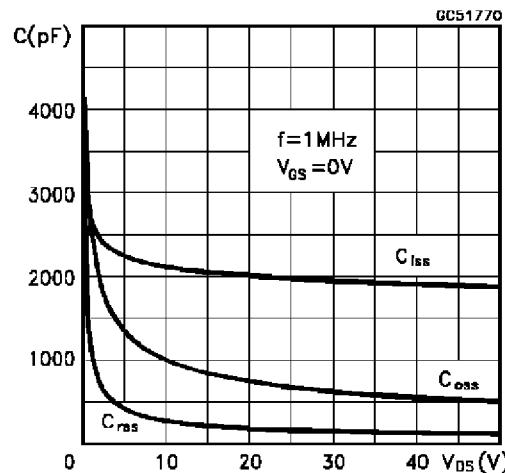
Static Drain-source On Resistance



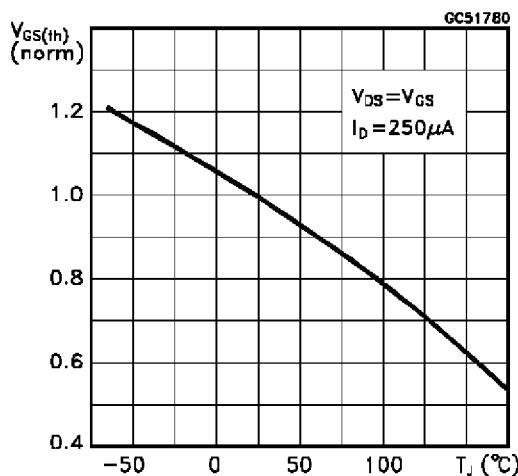
Gate Charge vs Gate-source Voltage



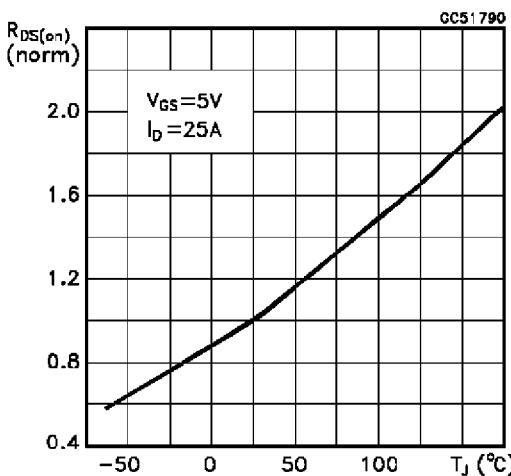
Capacitance Variations



Normalized Gate Threshold Voltage vs Temperature

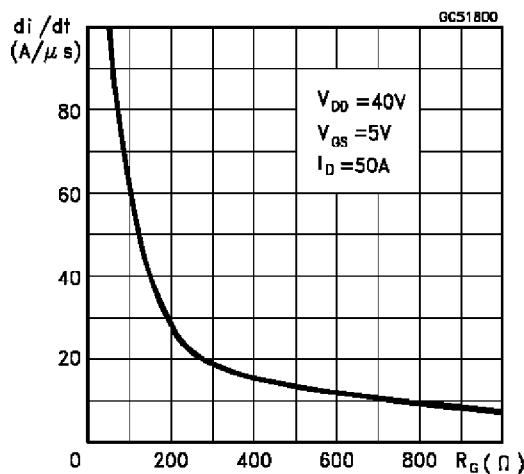


Normalized On Resistance vs Temperature

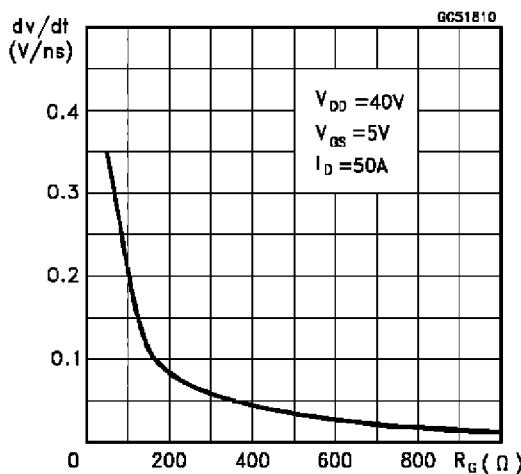


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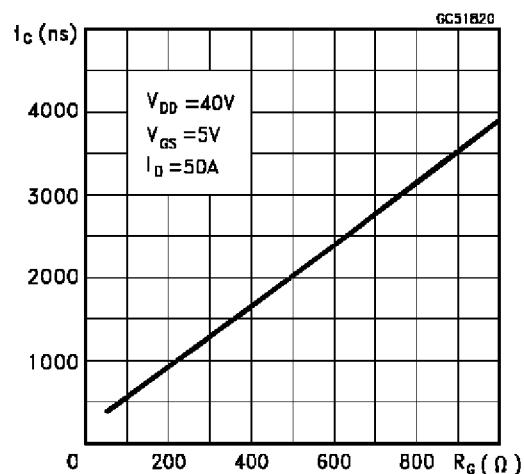
Turn-on Current Slope



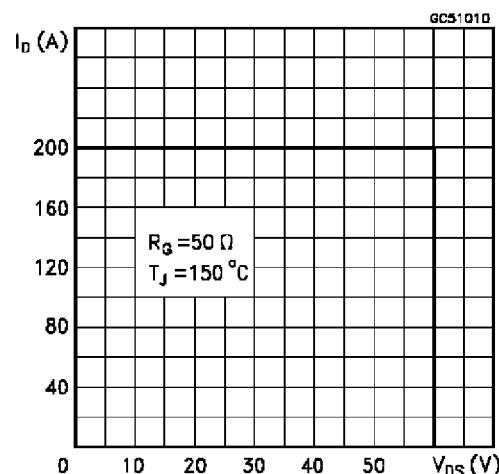
Turn-off Drain-source Voltage Slope



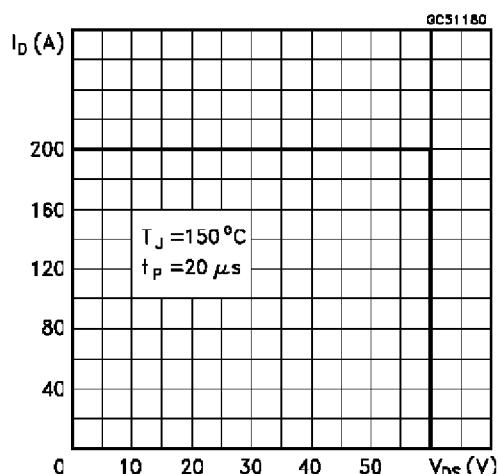
Cross-over Time



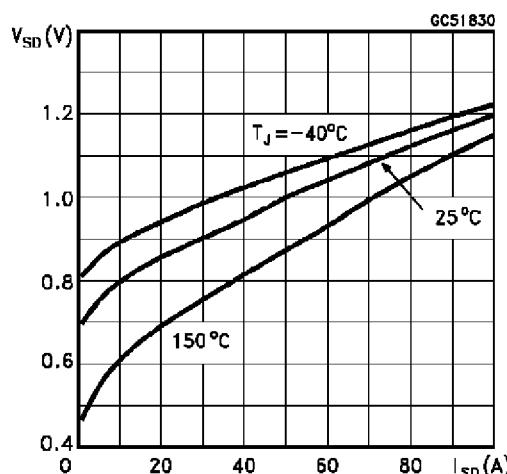
Switching Safe Operating Area



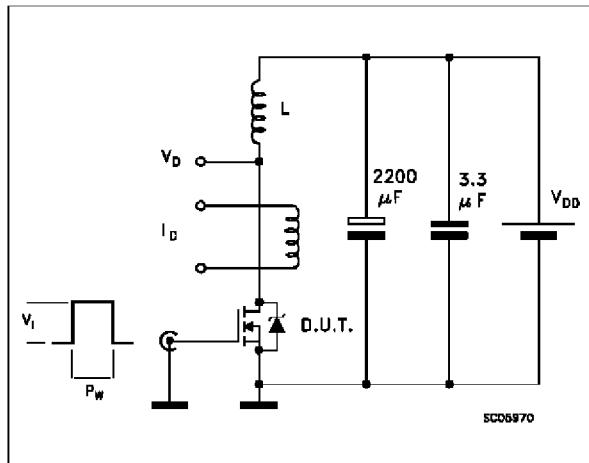
Accidental Overload Area



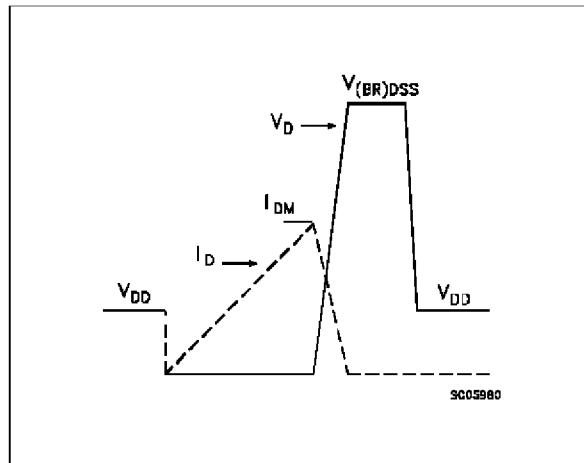
Source-drain Diode Forward Characteristics



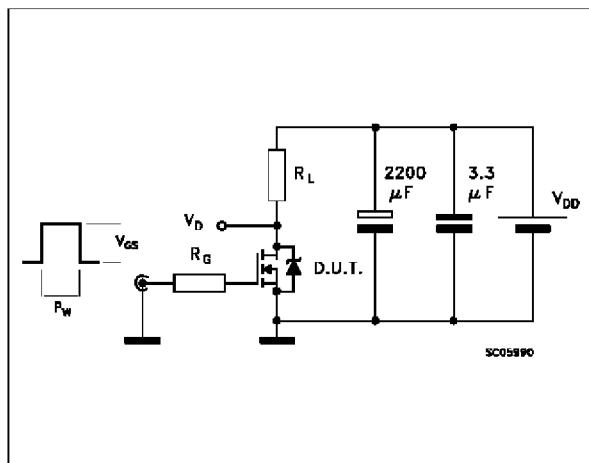
**Fig. 1:** Unclamped Inductive Load Test Circuits



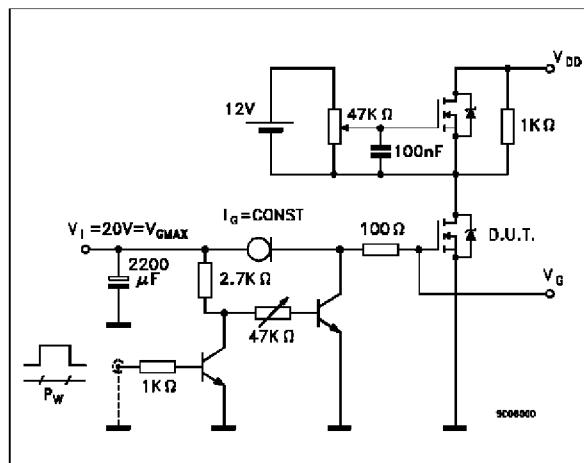
**Fig. 2:** Unclamped Inductive Waveforms



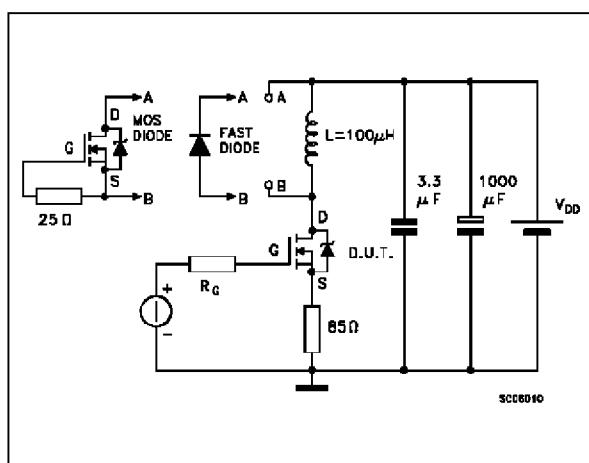
**Fig. 3:** Switching Times Test Circuits For Resistive Load



**Fig. 4:** Gate Charge Test Circuit

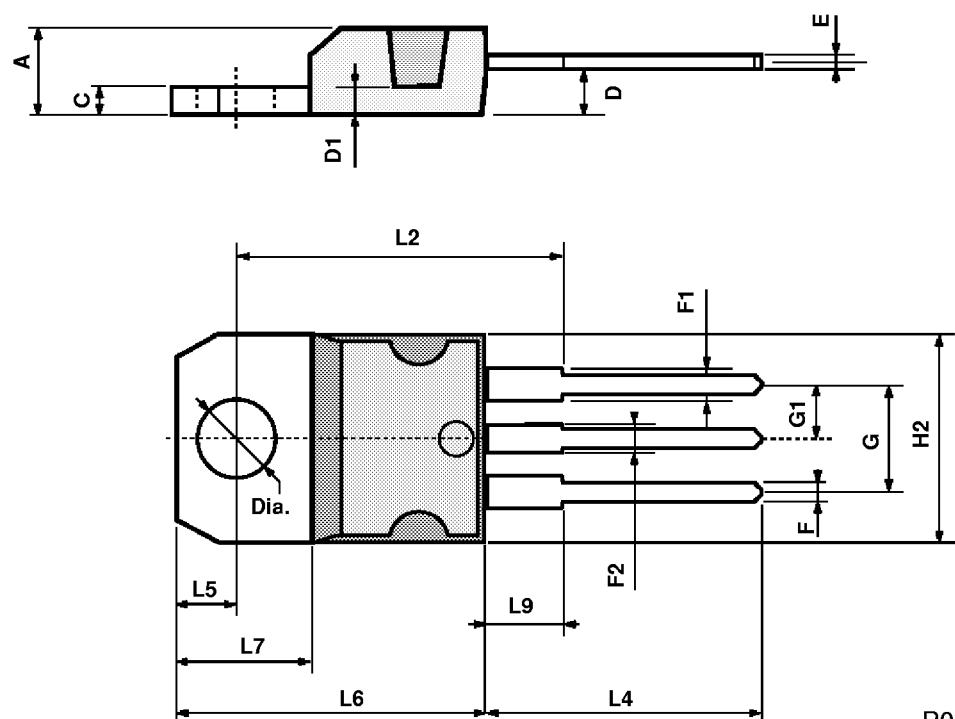


**Fig. 5:** Test Circuit For Inductive Load Switching And Diode Reverse Recovery Time



## **TO-220 MECHANICAL DATA**

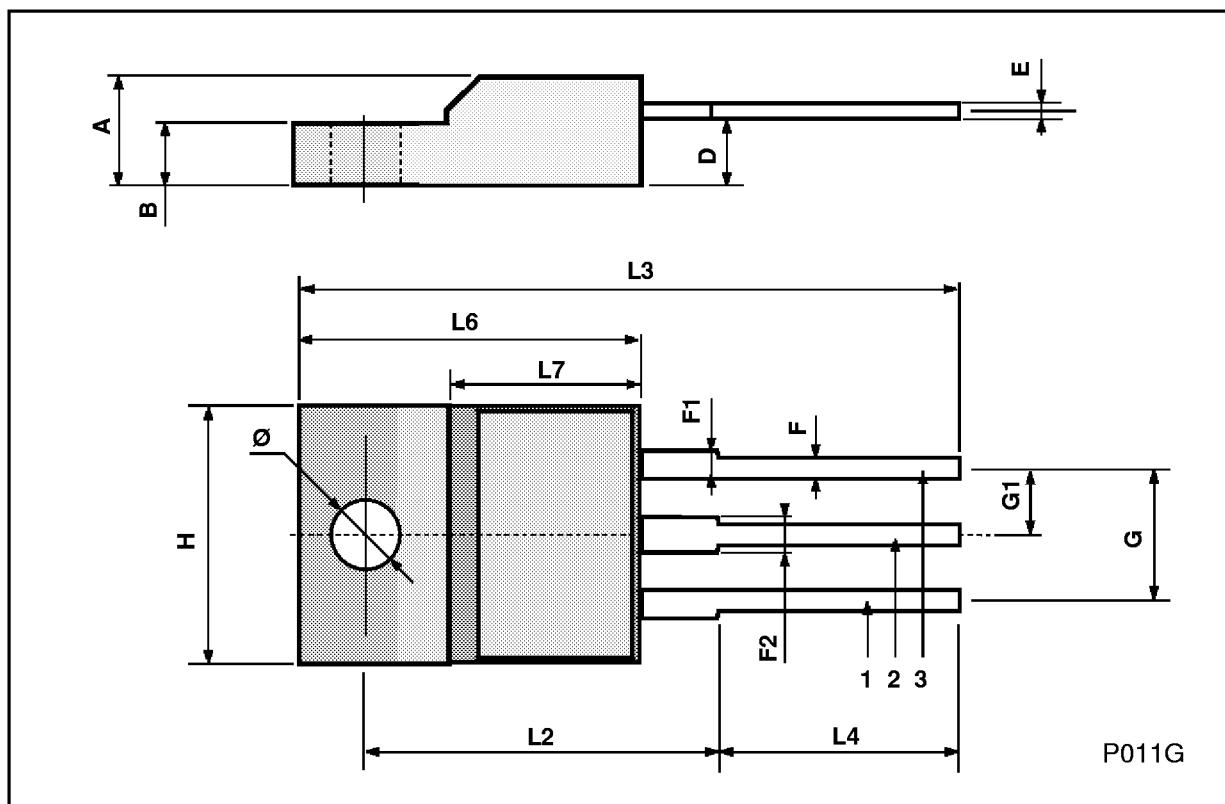
| DIM. | mm    |      |       | inch  |       |       |
|------|-------|------|-------|-------|-------|-------|
|      | MIN.  | TYP. | MAX.  | MIN.  | TYP.  | MAX.  |
| A    | 4.40  |      | 4.60  | 0.173 |       | 0.181 |
| C    | 1.23  |      | 1.32  | 0.048 |       | 0.051 |
| D    | 2.40  |      | 2.72  | 0.094 |       | 0.107 |
| D1   |       | 1.27 |       |       | 0.050 |       |
| E    | 0.49  |      | 0.70  | 0.019 |       | 0.027 |
| F    | 0.61  |      | 0.88  | 0.024 |       | 0.034 |
| F1   | 1.14  |      | 1.70  | 0.044 |       | 0.067 |
| F2   | 1.14  |      | 1.70  | 0.044 |       | 0.067 |
| G    | 4.95  |      | 5.15  | 0.194 |       | 0.203 |
| G1   | 2.4   |      | 2.7   | 0.094 |       | 0.106 |
| H2   | 10.0  |      | 10.40 | 0.393 |       | 0.409 |
| L2   |       | 16.4 |       |       | 0.645 |       |
| L4   | 13.0  |      | 14.0  | 0.511 |       | 0.551 |
| L5   | 2.65  |      | 2.95  | 0.104 |       | 0.116 |
| L6   | 15.25 |      | 15.75 | 0.600 |       | 0.620 |
| L7   | 6.2   |      | 6.6   | 0.244 |       | 0.260 |
| L9   | 3.5   |      | 3.93  | 0.137 |       | 0.154 |
| DIA. | 3.75  |      | 3.85  | 0.147 |       | 0.151 |



P011C

## ISOWATT220 MECHANICAL DATA

| DIM. | mm   |      |      | inch  |       |       |
|------|------|------|------|-------|-------|-------|
|      | MIN. | TYP. | MAX. | MIN.  | TYP.  | MAX.  |
| A    | 4.4  |      | 4.6  | 0.173 |       | 0.181 |
| B    | 2.5  |      | 2.7  | 0.098 |       | 0.106 |
| D    | 2.5  |      | 2.75 | 0.098 |       | 0.108 |
| E    | 0.4  |      | 0.7  | 0.015 |       | 0.027 |
| F    | 0.75 |      | 1    | 0.030 |       | 0.039 |
| F1   | 1.15 |      | 1.7  | 0.045 |       | 0.067 |
| F2   | 1.15 |      | 1.7  | 0.045 |       | 0.067 |
| G    | 4.95 |      | 5.2  | 0.195 |       | 0.204 |
| G1   | 2.4  |      | 2.7  | 0.094 |       | 0.106 |
| H    | 10   |      | 10.4 | 0.393 |       | 0.409 |
| L2   |      | 16   |      |       | 0.630 |       |
| L3   | 28.6 |      | 30.6 | 1.126 |       | 1.204 |
| L4   | 9.8  |      | 10.6 | 0.385 |       | 0.417 |
| L6   | 15.9 |      | 16.4 | 0.626 |       | 0.645 |
| L7   | 9    |      | 9.3  | 0.354 |       | 0.366 |
| Ø    | 3    |      | 3.2  | 0.118 |       | 0.126 |



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